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IEEE JNL IEEE Journal or Magazine

IEEE JNL IEEE Journal or Magazine

IEEE CNF IEEE Conference Proceeding

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IEEE STD IEEE Standard

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- ☐ 1. **INSPAD: a system for automatic bond pad inspection**
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[Semiconductor Manufacturing, IEEE Transactions on](#)
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- ☐ 2. **Improvement for bond pads discolor (slc) of CMOS image sensor produc**
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- ☐ 3. **Small-sized dual-band SAW filters using flip-chip bonding technology**
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[Ultrasonics Symposium, 1999. Proceedings, 1999 IEEE](#)
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- ☐ 4. **A mixed analog-digital secondary channel FSK modem**
 Chen, C.-S.; Huang, E.; White, B.J.;
[Solid-State Circuits Conference, 1989. Digest of Technical Papers. 36th ISSC\(](#)
[International](#)
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- ☐ 5. **A low-power 170-MHz discrete-time analog FIR filter**
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- ☐ **6. Electrical parasitic modeling in SAW RF filters**
Caron, J.J.; Malocha, S.;
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- ☐ **7. Surface mount type SAW filter for hand-held telephones**
Suma, S.; Gunji, K.; Tagami, T.; Sakamoto, Y.;
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- ☐ **8. A BiCMOS analog front-end circuit for an FDM-based ADSL system**
Langford, D.S.; Tesch, B.J.; Williams, B.E.; Nelson, G.R., Jr.;
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- ☐ **9. An automated method for inspection of IC bonds**
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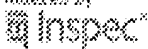
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- ☐ **11. Planar resonator and integrated oscillator using magnetostatic waves**
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- ☐ 13. **A single-chip multimode receiver for GSM900, DCS1800, PCS1900, and W**
Ryynanen, J.; Kivekas, K.; Jussila, J.; Sumanen, L.; Parssinen, A.; Halonen, K
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S6	737	S5 and capacitor and conductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/11 18:50